R2 Series For TO-220, TO-247, and TO-264





Ohmite's R2 Series (patent pending) heatsink provides a large surface area along with our C Series clipping mechanism to attach to a TO-220, TO-247, or TO-264 package. The self-aligning features of the clip assure secure attachment and enhanced thermal performance. Because no screws are required for device mounting, additional fins can be added to the rear side of the heatsink for increased total surface area in a more compact space.

FEATURES

- Reduced Assembly Cost: C Series camming clips make fasteners and fixtures obsolete, along with stray metal filings from tapped holes.
- Maximum Repeatability: clamping force of the clip is not degraded by repeated loading and unloading.
- Maximum Heat Transfer per Unit Space: maximum surface area per unit volume and consistent mounting force reduces thermal resistance
- Maximum Resistance to Shock and Vibration: light weight, resilient clips lock the component in place and are highly resistant to shock and vibration
- Maximum Reliability: helps prevent short circuits by eliminating metal particles from thread tapping
- RoHS compliant

SERIES SPECIFICATIONS				
Heatsink Part Number	Surface Area (in²/mm²)	Weight (oz/g)	Thermal Resistance* (°C/W)	
R2V-CT2-38E	21 / 13,579	0.92 / 26	9.8	
R2A-CT2-38E	21 / 13,579	0.92 / 26	8.6	
R2V-CT4-38E	21 / 13,579	1.02 / 29	9.8	
R2A-CT4-38E	21 / 13,579	1.02 / 29	8.6	
R2V-CT6-38E	21 / 13,579	1.02 / 29	9.8	
R2A-CT6-38E	21 / 13,579	1.02 / 29	8.6	
*Free convection at 15W			5.0	

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CHARACTERISTICS			
Heat Sink	Aluminum Alloy 6063-T5 or Equivalent with either degreased or black anodized finish		
Spring Clip	Music Wire, Per ASTM A228 with bright nickel plating		
Solder Foot	Cold-rolled Steel, Per ASTM A-366 with pure tin over copper strike. RoHS compli- ant		
Interface Thermal Resistance	for improvement, use thermal joint compound, 0.005 Grafoil (TGon 800 by Laird), or phase change material (Hi-Flow by Bergquist)		
Insulator	(Optional) Sil-Pad 900-S, K6 800-S and K10		

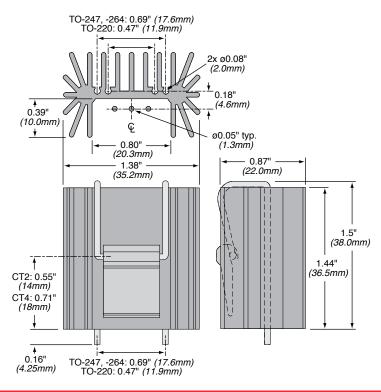
(continued)



R2 Series For T0-220, T0-247, and T0-264

HEAT DISSIPATION TO-247 with no thermal Air Velocity (ft./min.) 100 200 300 400 500 600 700 800 900 1000 3.5 0 interface material 160 140 3 Case Temp Rise Above Ambient in Free Air (°C) 09 08 00 09 09 Thermal Resistance Case to Ambient (°C/W) 2.5 2 1.5 1 0.5 20 0 0 2 10 16 18 20 0 4 6 8 12 14 Heat Dissipated (watts)

DIMENSIONS



HOW TO ORDER

